

AN 1993-278158 JAPIO  
TI METAL-METAL INCLINATION FUNCTION MATERIAL  
IN FUKAO YOICHI  
PA TOSHIBA CORP  
PI JP 05278158 A 19931026 Heisei  
AI JP 1992-76805 (JP04076805 Heisei) 19920331  
PRAI JP 1992-76805 19920331  
SO PATENT ABSTRACTS OF JAPAN (CD-ROM), Unexamined Applications, Vol. 1993  
AB PURPOSE: To provide a metal-metal bonded material withstanding high stress load by excluding a stress concn. source by constituting the bonded region to have a continuous composition change.  
CONSTITUTION: In metals A, B mutually forming a perfect solid solution, a bonded material consists of a first metal layer composed of the metal A or a metal A base alloy and a second metal layer composed of the metal B or a metal B base alloy and the bonded part of the first and second metal layers is composed of a solid solution phase wherein the first and second metal components continue.  
COPYRIGHT: (C)1993,JPO&Japio